

Technical Data Data Sheet N0708, Rev. - **Green Products**

50WQ04FN SCHOTTKY RECTIFIER

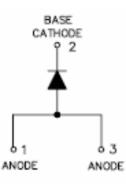
Applications:

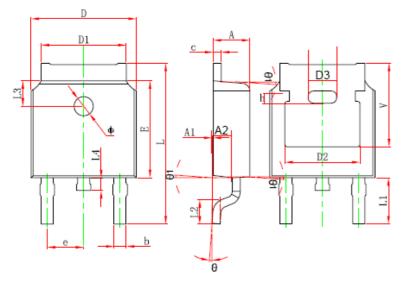
- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Features:

- Popular DPAK outline
- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Green products in compliance with the ROHS directive
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Dimensions: In mm / Inches





Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.380	0.087	0.094	
A1	0.000	0.100	0.000	0.004	
b	0.710	0.810	0.028	0.032	
с	0.460	0.560	0.018	0.022	
D	6.500	6.700	0.256	0.264	
D1	5.130	5.460	0.202	0.215	
D2	4.830) REF.	0.190) REF.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	REF.	0.114 REF.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 REF.		0.063	REF.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
A2	0.910	1.110	0.036	0.044	
V	5.350 REF.		0.211 REF.		
D3	1.778	1.778REF. 0.070REF.		REF.	
h	0.762REF.		0.030REF.		
0 1	7°		7°		

DPAK



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Marking Diagram:

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Where XXXXX is YYWWL

_	
	50WQ04FN SSG XXXXX

50	= Forward Current (5A)
W	= Configuration
Q	= Device Type
04	= Reverse Voltage (40V)
FN	= Package type
SSG	= SSG
ΥY	= Year
WW	= Week
L	= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
50WQ04FN	DPAK	2500 peg / real
	(Pb-Free)	2500 pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	Vrwm	-	40	V
Average Forward Current* (per device)	I _{F(AV)}	50% duty cycle @T _C = 135℃, rectangular wave form	5.5	А
Peak One Cycle Non- Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine pulse	84	А

• Weiqi Street, Airport Development Zone, Jiangning District, Nanjing, China 211113 🗏 (86) 25-87123907 • • FAX (86) 25-87123900 • World Wide Web Site - http://www.sangdest.com.cn • E-Mail Address - sales@ sangdest.com.cn •



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Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Forward Voltage Drop*	V	@ 5A, Pulse, T _J = 25 °C	0.51	V
	V_{F1}	@ 10A, Pulse, T _J = 25 °C	0.63	v
	V _{F2}	@ 5 A, Pulse, T _J = 125 °C	0.44	V
	v F2	@ 10 A, Pulse, T _J = 125 °C	0.59	v
Reverse Current *	I _{R1}	$@V_{R} = rated V_{R}$	3.0	mA
	IR1	T _J = 25 °C	5.0	ША
	I _{R2}	$@V_{R} = rated V_{R}$	40	mA
	IR2	T _J = 125 °C	40	ША
Junction Capacitance	Cτ	@V _R = 5V, T _C = 25 °C	405	pF
(per leg)	UT	f _{SIG} = 1MHz	405	рі
Typical Series Inductance	Ls	Measured lead to lead 5 mm	5.0	nH
(per leg)	∟s	from package body	5.0	1111
Max. Voltage Rate of Change	dv/dt	-	10,000	V/µs

* Pulse Width < 300µs, Duty Cycle <2%

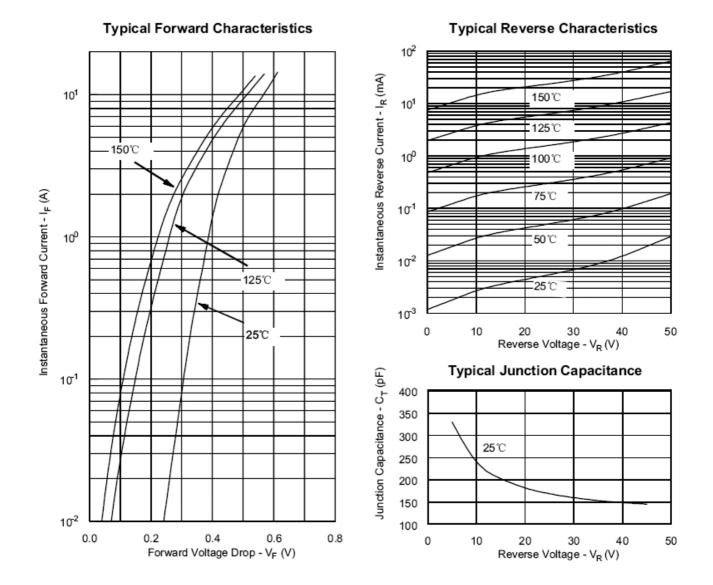
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	ΤJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Maximum Thermal Resistance Junction to Case (per leg)	R _{θJC}	DC operation	3.0	°C/W
Approximate Weight	wt	-	0.39	g
Case Style		DPAK		



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